

CLCC1V2012

Common mode inductor



Product features

- High impedance at high frequency
- Excellent noise suppression performance
- 0805 (2012 metric) compact package
- Weight 0.013 grams typical
- Moisture sensitivity level (MSL): 1
- Use with CLCC2V3216 auto-transformer for capacitive chip LAN applications

Applications

- 1 G, 2.5 G BASE-T applications
- RJ45 network interface card
- Ethernet switch, router, ADSL
- VDSL digital equipment
- Network set-top box
- Smart TV
- Network camera
- PC motherboard
- Industrial motherboard

Environmental compliance and general specifications

- Operating temperature range: -40 °C to +85 °C (ambient plus self-temperature rise)
- Storage temperature range: -40 °C to +85 °C (component)



Product specifications

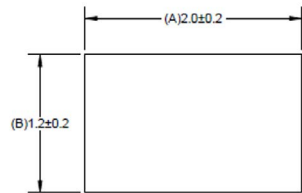
Part number	Impedance ¹ (Ω) @ 100 MHz	Inductance ² (Ω) @ 100 kHz (uH) minimum	DCR ³ (Ω) @ +25 °C maximum	Rated current ⁴ (mA) maximum	Rated voltage ⁴ (Vdc) maximum	Withstand voltage ⁵ (Vdc) maximum	Insulation resistance ⁵ (MΩ minimum)
CLCC1V2012-801-R	800 ± 25%	2.0	0.88	300	50	125	10

1. Impedance: pins (1,2 - 3,4), test frequency parameters: 100 MHz, 0.1 V @ +25 °C
2. Inductance: pins (1-4), (2-3), test frequency parameters: 100 kHz, 0.1 V @ +25 °C
3. DCR: pins (1-4), (2-3), @ +25 °C

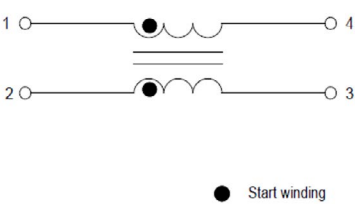
4. Rated current and rated voltage: pins (1-2) short (3-4), based on a temperature rise of approximately 20 °C
5. Withstand voltage: (1 mA, 1 s), Insulation resistance (50 V, 1 s): pins (1,4) - (2,3)

Mechanical parameters, schematic, pad layout (mm)

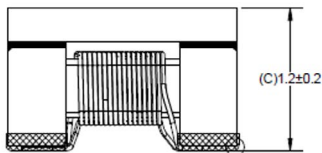
Top view



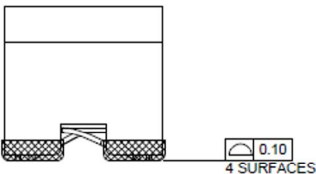
Schematic



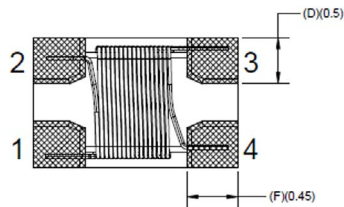
Front view



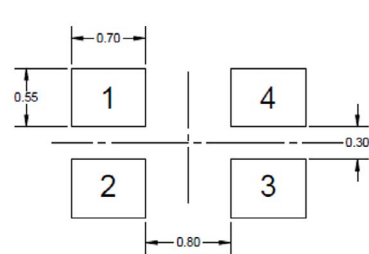
Right view



Bottom view



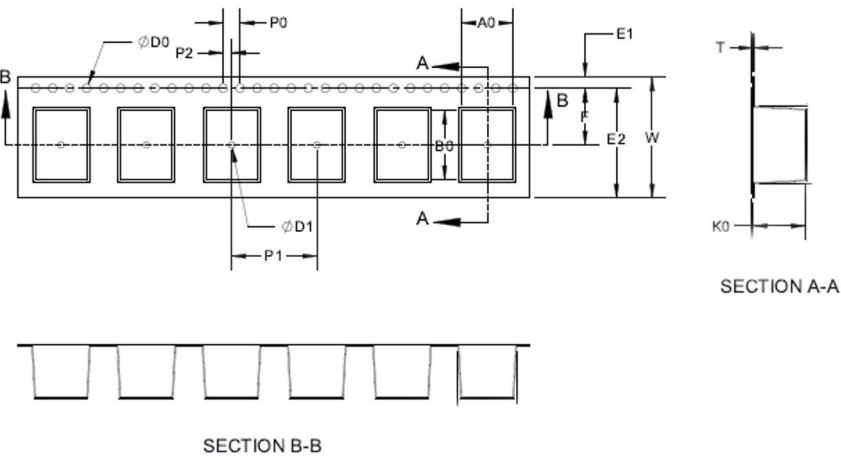
Recommended pad layout



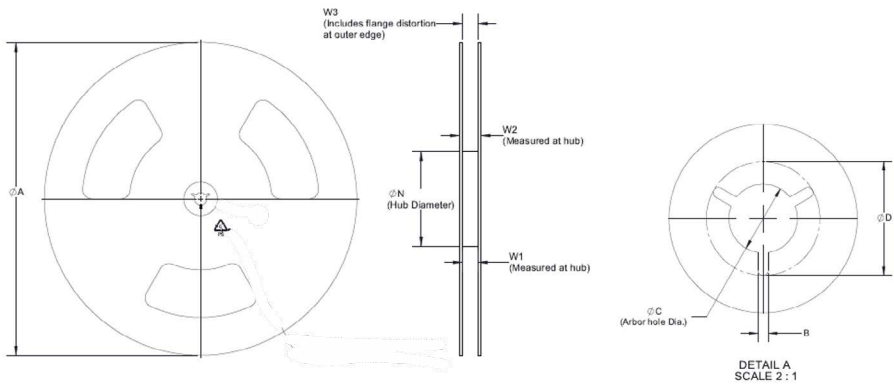
Part marking: No marking
All soldering surfaces to be coplanar within 0.1 millimeters
Silkscreen thickness: 0.1 - 0.15 mm
Traces or vias underneath the inductor is not recommended

Packaging information (mm)

Supplied in tape and reel packaging, 10,000 parts per 13" diameter reel (EIA-481 compliant)

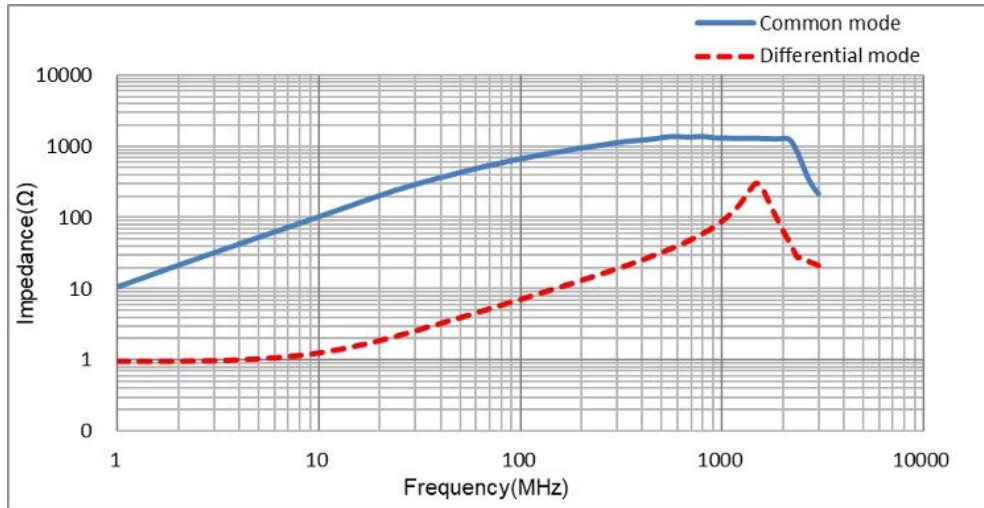


Dimension	CLCC1V2012
A0	1.45 ± 0.1
B0	2.25 ± 0.1
K0	1.47 ± 0.1
T	0.26 ± 0.05
W	8 ± 0.1
F	3.50 ± 0.1
E1	1.75 ± 0.1
E2	5.25 minimum
P0	4 ± 0.1
P1	4 ± 0.1
P2	2 ± 0.05
D0	1.50 + 0.1/-0
D1	0.65 + 0.1/-0



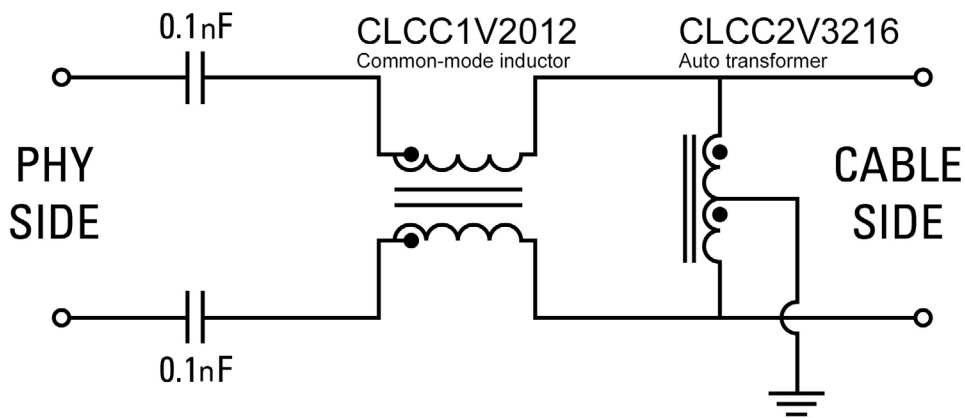
Dimension	CLCC1V2012
Type	13"*8
A	330 ± 2
B	3.20 ± 0.3
C	13 + 0.5/-0.2
D	20.20 minimum
N	100 ± 2
W1	8.4 + 1.5/-0
W2	12.60 ± 0.3
W3	N/A

Impedance vs frequency



Application example

Voltage driving capacitive chip LAN circuit using Eaton CLCC1V2012 common-mode inductor and CLCC2V3216 auto transformer



Solder reflow profile

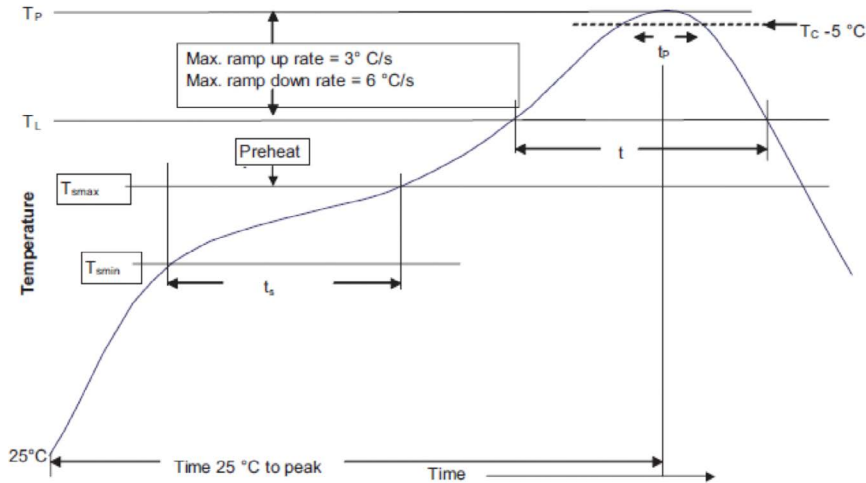


Table 1 - Standard SnPb solder (T_C)

Package Thickness	Volume mm ³ <350	Volume mm ³ ≥350
<2.5 mm)	235 °C	220 °C
≥2.5 mm	220 °C	220 °C

Table 2 - Lead (Pb) free solder (T_C)

Package thickness	Volume mm ³ <350	Volume mm ³ 350 - 2000	Volume mm ³ >2000
<1.6 mm	260 °C	260 °C	260 °C
1.6 – 2.5 mm	260 °C	250 °C	245 °C
>2.5 mm	250 °C	245 °C	245 °C

Reference J-STD-020

Profile feature	Standard SnPb solder	Lead (Pb) free solder
Preheat and soak		
• Temperature min. (T_{smin})	100 °C	150 °C
• Temperature max. (T_{smax})	150 °C	200 °C
• Time (T_{smin} to T_{smax}) (t_s)	60-120 seconds	60-120 seconds
Ramp up rate T_L to T_P	3 °C/ second max.	3 °C/ second max.
Liquidous temperature (T_L)	183 °C	217 °C
Time (t_L) maintained above T_L	60-150 seconds	60-150 seconds
Peak package body temperature (T_P)*	Table 1	Table 2
Time (t_P)* within 5 °C of the specified classification temperature (T_C)	20 seconds*	30 seconds*
Ramp-down rate (T_P to T_L)	6 °C/ second max.	6 °C/ second max.
Time 25 °C to peak temperature	6 minutes max.	8 minutes max.

* Tolerance for peak profile temperature (T_P) is defined as a supplier minimum and a user maximum.

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